



## Product Change Notification / SYST-23ZVMN538

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**Date:**

24-Feb-2022

**Product Category:**

8-bit Microcontrollers

**PCN Type:**

Document Change

**Notification Subject:**

ERRATA - AVR64DA28/32/48/64 Silicon Errata and Data Sheet Clarification Document Revision

**Affected CPNs:**

[SYST-23ZVMN538\\_Affected\\_CPN\\_02242022.pdf](#)

[SYST-23ZVMN538\\_Affected\\_CPN\\_02242022.csv](#)

**Notification Text:**

SYST-23ZVMN538

Microchip has released a new Product Documents for the AVR64DA28/32/48/64 Silicon Errata and Data Sheet Clarification of devices. If you are using one of these devices please read the document located at [AVR64DA28/ 32/ 48/ 64 Silicon Errata and Data Sheet Clarification](#).

**Notification Status:** Final

**Description of Change:**

- 1) Added data sheet clarifications:
  - 3.1. Features
  - 3.2. FUSE - Configuration and User Fuses
  - 3.5. Electrical Characteristics - Peripheral Power Consumption
  - 3.6. Electrical Characteristics - Memory Programming Specifications
  - 3.7. Electrical Characteristics - VREF
  - 3.8. Electrical Characteristics - DAC
  - 3.9. Electrical Characteristics - ADC
- 2) Updated data sheet clarifications:
  - 3.3. RSTCTRL - Reset Controller
  - 3.4. TWI - Two-Wire Interface

**Impacts to Data Sheet:** None

**Reason for Change:** To Improve Productivity

**Change Implementation Status:** Complete

**Date Document Changes Effective:** 24 Feb 2022

**NOTE:** Please be advised that this is a change to the document only the product has not been changed.

## **Attachments:**

[AVR64DA28/32/48/64 Silicon Errata and Data Sheet Clarification](#)

Please contact your local [Microchip sales office](#) with questions or concerns regarding this notification.

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Affected Catalog Part Numbers (CPN)

AVR64DA28-E/SO  
AVR64DA28-E/SP  
AVR64DA28-E/SS  
AVR64DA28-E/SSVAO  
AVR64DA28-I/SO  
AVR64DA28-I/SP  
AVR64DA28-I/SS  
AVR64DA28T-E/SO  
AVR64DA28T-E/SS  
AVR64DA28T-E/SSV02  
AVR64DA28T-E/SSVAO  
AVR64DA28T-I/SO  
AVR64DA28T-I/SS  
AVR64DA32-E/PT  
AVR64DA32-E/PTVAO  
AVR64DA32-E/RXB  
AVR64DA32-E/RXBVAO  
AVR64DA32-I/PT  
AVR64DA32-I/RXB  
AVR64DA32T-E/PT  
AVR64DA32T-E/PTV03  
AVR64DA32T-E/PTVAO  
AVR64DA32T-E/RXB  
AVR64DA32T-E/RXBV01  
AVR64DA32T-E/RXBVAO  
AVR64DA32T-I/PT  
AVR64DA32T-I/RXB  
AVR64DA48-E/6LX  
AVR64DA48-E/6LXVAO  
AVR64DA48-E/PT  
AVR64DA48-E/PTVAO  
AVR64DA48-I/6LX  
AVR64DA48-I/PT  
AVR64DA48T-E/6LX  
AVR64DA48T-E/6LXV05  
AVR64DA48T-E/6LXVAO  
AVR64DA48T-E/PT  
AVR64DA48T-E/PTV04  
AVR64DA48T-E/PTVAO  
AVR64DA48T-I/6LX  
AVR64DA48T-I/PT  
AVR64DA64-E/MR  
AVR64DA64-E/PT  
AVR64DA64-I/MR  
AVR64DA64-I/PT  
AVR64DA64T-E/MR

AVR64DA64T-E/PT  
AVR64DA64T-I/MR  
AVR64DA64T-I/PT



# AVR64DA28/32/48/64

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## AVR64DA Silicon Errata and Data Sheet Clarification

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The AVR64DA28/32/48/64 devices you have received conform functionally to the current device data sheet ([www.microchip.com/DS40002233](http://www.microchip.com/DS40002233)), except for the anomalies described in this document. The errata described in this document will likely be addressed in future revisions of the AVR64DA28/32/48/64 devices.

**Notes:**

- This document summarizes all the silicon errata issues from all the silicon revisions, previous as well as current
- Refer to the Device/Revision ID section in the current device data sheet ([www.microchip.com/DS40002233](http://www.microchip.com/DS40002233)) for more detailed information on Device Identification and Revision IDs for your specific device, or contact your local Microchip sales office for assistance

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## 1. Silicon Issue Summary

### Legend

- Erratum is not applicable.
- X Erratum is applicable.

Peripheral	Short Description	Valid for Silicon Revision	
		Rev. A3 <sup>(1)</sup>	Rev. A4
Device	2.2.1. Some Reserved Fuse Bits Are '1'	X	X
	2.2.2. CRC Check During Reset Initialization Is not Functional	X	X
CCL	2.3.1. The LINK Input Source Selection for LUT3 Is not Functional on 28- and 32-Pin Devices	X	X
CLKCTRL	2.4.1. PLL Status not Working as Expected	X	X
DAC	2.5.1. DAC Output Buffer Lifetime Drift	X	X
NVMCTRL	2.6.1. Flash Multi-Page Erase Can Erase Write Protected Section	X	X
PORT	2.7.1. Digital Input on Pin Automatically Disabled When Pin Selected for Analog Input	X	X
RSTCTRL	2.8.1. BOD Registers not Reset When UPDI Is Enabled	X	X
TCA	2.9.1. Restart Will Reset Counter Direction in NORMAL and FRQ Mode	X	X
TCB	2.10.1. CCMP and CNT Registers Operate as 16-Bit Registers in 8-Bit PWM Mode	X	X
TCD	2.11.1. Asynchronous Input Events not Working When TCD Counter Prescaler Is Used	X	X
	2.11.2. CMPAEN Controls All WOx for Alternative Pin Functions	X	X
	2.11.3. Halting TCD and Wait for SW Restart Does Not Work if Compare Value A is 0 or Dual Slope Mode is Used	X	X
TWI	2.12.1. The Output Pin Override Does not Function as Expected	X	X
	2.12.2. Flush Non-Functional	X	X
USART	2.13.1. Open-Drain Mode Does not Work When TXD Is Configured as Output	X	X
	2.13.2. Start-of-Frame Detection Can Unintentionally Be Triggered in Active Mode	X	X
ZCD	2.14.1. All ZCD Output Selection Bits Are Tied to the ZCD0 Bit	X	X

### Note:

1. This revision is the initial release of the silicon.

## 2. Silicon Errata Issues

### 2.1 Errata Details

- Erratum is not applicable.
- X Erratum is applicable.

### 2.2 Device

#### 2.2.1 Some Reserved Fuse Bits Are '1'

For material with date code 2033 (manufactured in the year 2020, week 33) or older, the default fuse values are not compliant with the data sheet. The fuse values will read out as listed below:

- BODCFG = 0x10
- OSCCFG = 0x78 (The device will use the OSCHF clock source)
- SYSCFG0 = 0xF2
- SYSCFG1 = 0xF8

#### Work Around

None.

#### Affected Silicon Revisions

Rev. A3	Rev. A4
X	X

#### 2.2.2 CRC Check During Reset Initialization Is not Functional

For material with date code 2136 (manufactured in the year 2021, week 36) or older, the CRCSRC bit field in the SYSCFG0 fuse is ignored during Reset initialization. A CRC check will not be performed during Reset initialization. CRCSCAN is only available from the software.

#### Work Around

None.

#### Affected Silicon Revisions

Rev. A3	Rev. A4
X	X

## 2.3 CCL - Configurable Custom Logic

### 2.3.1 The LINK Input Source Selection for LUT3 Is not Functional on 28- and 32-Pin Devices

The LINK option (INSELn in LUT3CTRLB or LUT3CTRLC is '0x2') does not work; the output from LUT0 will not get connected as an input to LUT3. This occurs only on 28-pin and 32-pin devices.

#### Work Around

Connect LUT0 output to LUT3 input using the Event System.



**Affected Silicon Revisions**

Rev. A3	Rev. A4
X	X

**2.4 CLKCTRL - Clock Controller****2.4.1 PLL Status not Working as Expected**

The PLL Status (PLLS) bit in the Main Clock Status (MCLKSTATUS) register will never be set to '1' if the Run Standby (RUNSTDBY) bit in PLL Control A (PLLCTRLA) register is set to '1' and no peripherals are requesting the PLL oscillator.

**Work Around**

None.

**Affected Silicon Revisions**

Rev. A3	Rev. A4
X	X

**2.5 DAC - Digital-to-Analog Converter****2.5.1 DAC Output Buffer Lifetime Drift**

The offset of the DAC output buffer can drift over lifetime if the device is powered with the DAC output buffer disabled.

**Work Around**

Keep the DAC output buffer enabled (OUTEN in DACn.CTRLA is '1') continuously or compensate by measuring the DAC output voltage offset with the ADC and adjust the DAC data register value (DATA[9:0] in DACn.DATA) accordingly.

**Affected Silicon Revisions**

Rev. A3	Rev. A4
X	X

**2.6 NVMCTRL - Nonvolatile Memory Controller****2.6.1 Flash Multi-Page Erase Can Erase Write Protected Section**

When using Flash Multi-Page Erase mode, only the first page in the selected address range is verified to be within a section that is not write-protected. If the address range includes any write-protected Application Data pages, it will erase them.

**Work Around**

None.

**Affected Silicon Revisions**

Rev. A3	Rev. A4
X	X

**2.7 PORT - I/O Configuration****2.7.1 Digital Input on Pin Automatically Disabled When Pin Selected for Analog Input**

If an input pin is selected to be analog input, the digital input function for those pins is automatically disabled.

**Work Around**

None

**Affected Silicon Revisions**

Rev. A3	Rev. A4
X	X

**2.8 RSTCTRL - Reset Controller****2.8.1 BOD Registers not Reset When UPDI Is Enabled**

If the UPDI is enabled, the VLMCTRL, INTCTRL, and INTFLAGS registers in BOD will not be reset by other reset sources than POR.

**Work Around**

None

**Affected Silicon Revisions**

Rev. A3	Rev. A4
X	X

**2.9 TCA - 16-Bit Timer/Counter Type A****2.9.1 Restart Will Reset Counter Direction in NORMAL and FRQ Mode**

When the TCA is configured to a NORMAL or FRQ mode (WGMODE in TCAn.CTRLB is '0x0' or '0x1'), a RESTART command or Restart event will reset the count direction to default. The default is counting upwards.

**Work Around**

None.

**Affected Silicon Revisions**

Rev. A3	Rev. A4
X	X

## 2.10 TCB - 16-Bit Timer/Counter Type B

### 2.10.1 CCMP and CNT Registers Operate as 16-Bit Registers in 8-Bit PWM Mode

When the TCB is operating in 8-bit PWM mode (CNTMODE in TCBn.CTRLB is '0x7'), the low and high bytes for the CNT and CCMP registers operate as 16-bit registers for read and write. They cannot be read or written independently.

#### Work Around

Use 16-bit register access. Refer to the data sheet for further information.

#### Affected Silicon Revisions

Rev. A3	Rev. A4
X	X

## 2.11 TCD - 12-Bit Timer/Counter Type D

### 2.11.1 Asynchronous Input Events not Working When TCD Counter Prescaler Is Used

When configuring TCD to use asynchronous input events (CFG in TCDn.EVCTRLx is '0x2') and the TCD Counter Prescaler (CNTPRES in TCDn.CTRLA) is different from '0x0', events can be missed.

#### Work Around

Use the TCD Synchronization Prescaler (SYNCPRES in TCDn.CTRLA) instead of the TCD Counter Prescaler. Alternatively, use synchronous input events (CFG in TCDn.EVCTRLx is not '0x2') if the input events are longer than one CLK\_TCD\_CNT cycle.

#### Affected Silicon Revisions

Rev. A3	Rev. A4
X	X

### 2.11.2 CMPAEN Controls All WOx for Alternative Pin Functions

When TCD alternative pins are enabled (TCD0 in PORTMUX.TCDROUTEA is not '0x0'), all waveform outputs (WOx) are controlled by Compare A Enable (CMPAEN in TCDn.FAULTCTRL).

#### Work Around

None.

#### Affected Silicon Revisions

Rev. A3	Rev. A4
X	X

### 2.11.3 Halting TCD and Wait for SW Restart Does Not Work if Compare Value A is 0 or Dual Slope Mode is Used

Halting TCD and wait for software restart (INPUTMODE in TCDn.INPUTCTRLA is '0x7') does not work if compare value A is 0 (CMPASET in TCDn.CMPASET is '0x0') or Dual Slope mode is used (WGMODE in TCDn.CTRLB is '0x3').

**Work Around**

Configure the compare value A (CMPASET in TCDn.CMPASET) to be different from 0 and do not use Dual Slope mode (WGMODE in TCDn.CTRLB is not '0x3').

**Affected Silicon Revisions**

Rev. A3	Rev. A4
X	X

**2.12 TWI - Two-Wire Interface****2.12.1 The Output Pin Override Does not Function as Expected**

When TWI is enabled, it overrides the output pin driver, but not the output value. The output on the line will always be high when the value in the PORTx.OUT register is '1' for the pins corresponding to the SDA or SCL.

**Work Around**

Ensure that the values in the PORTx.OUT register corresponding to the SCL and SDA pins are '0' before enabling the TWI.

**Affected Silicon Revisions**

Rev. A3	Rev. A4
X	X

**2.12.2 Flush Non-Functional**

Issuing a Flush by writing to the FLUSH bit in TWIn.MCTRLB can cause the TWI Host to be stuck in Unknown bus state (see BUSSTATE in TWIn.MSTATUS).

**Work Around**

Disable and re-enable the Host using the ENABLE bit in TWIn.MCTRLA. A normal operation does not require the use of FLUSH.

**Affected Silicon Revisions**

Rev. A3	Rev. A4
X	X

**2.13 USART - Universal Synchronous and Asynchronous Receiver and Transmitter****2.13.1 Open-Drain Mode Does not Work When TXD Is Configured as Output**

When configured as an output, the USART TXD pin can drive the pin high regardless of whether the Open-Drain mode is enabled or not.

**Work Around**

Configure the TXD pin as an input by writing the corresponding bit in PORTx.DIR to '0' when using Open-Drain mode.

**Affected Silicon Revisions**

Rev. A3	Rev. A4
X	X

**2.13.2 Start-of-Frame Detection Can Unintentionally Be Triggered in Active Mode**

The Start-of-Frame Detection feature enables the USART to wake up from Standby sleep mode upon data reception. The Start-of-Frame Detector can unintentionally be triggered when the Start-of-Frame Detection Enable (SFDEN) bit in the USART Control B (USARTn.CTRLB) register is set, and the device is in Active mode. If the Receive Data (RXDATA) registers are read while receiving new data, the Receive Complete Interrupt Flag (RXCIF) in the USARTn.STATUS register is cleared. This triggers the Start-of-Frame Detector and falsely detects the following falling edge as a start bit. When the Start-of-Frame Detector detects a start condition, the frame reception is restarted, resulting in corrupt received data. Note that the USART Receive Start Interrupt Flag (RXSIF) always is '0' when in Active mode. No interrupt will be triggered.

**Work Around**

Disable Start-of-Frame Detection by writing '0' to the Start-of-Frame Detection Enable (SFDEN) bit in the USART Control B (USARTn.CTRLB) register when the device is in Active mode. Re-enable it by writing the bit to '1' before transitioning to Standby sleep mode. This work around depends on a protocol preventing a new incoming frame when re-enabling Start-of-Frame Detection. Re-enabling Start-of-Frame Detection, while a new frame is already incoming, will result in corrupted received data.

**Affected Silicon Revisions**

Rev. A3	Rev. A4
X	X

**2.14 ZCD - Zero-Cross Detector****2.14.1 All ZCD Output Selection Bits Are Tied to the ZCD0 Bit**

The Zero Cross Detector n Output (ZCDn) bits in the Pin Position (PORTMUX.ZCDROUTEA) register are tied to ZCD0. Any write to ZCD0 will be reflected in the ZCD1 and ZCD2 as well. Writing to ZCD1 and/or ZCD2 has no effect.

**Work Around**

Use the Event System or CCL to make the output of ZCD1 or ZCD2 available on a pin.

**Affected Silicon Revisions**

Rev. A3	Rev. A4
X	X

### 3. Data Sheet Clarifications

The following typographic corrections and clarifications are to be noted for the latest version of the device data sheet ([www.microchip.com/DS40002233](http://www.microchip.com/DS40002233)).

**Note:** Corrections are shown in **bold**. Where possible, the original bold text formatting has been removed for clarity.

#### 3.1 Features

A clarification has been made to change the Flash endurance specification in the *Memories* bullet point in the *Features* list.

- Memories
  - 128 KB in-system self-programmable Flash memory
  - 512B EEPROM
  - 16 KB SRAM
  - 32B of user row in nonvolatile memory that can keep data during chip-erase and be programmed while the device is locked
  - Write/erase endurance
    - Flash: **1,000** cycles
    - EEPROM: 100,000 cycles
  - Data retention: 40 years at 55°C

#### 3.2 FUSE - Configuration and User Fuses

A clarification of the EEPROM Save During Chip Erase (EESAVE) fuse description in the System Configuration 0 (SYSCFG0) fuse has been made.

##### Bit 0 - EESAVE EEPROM Save During Chip Erase

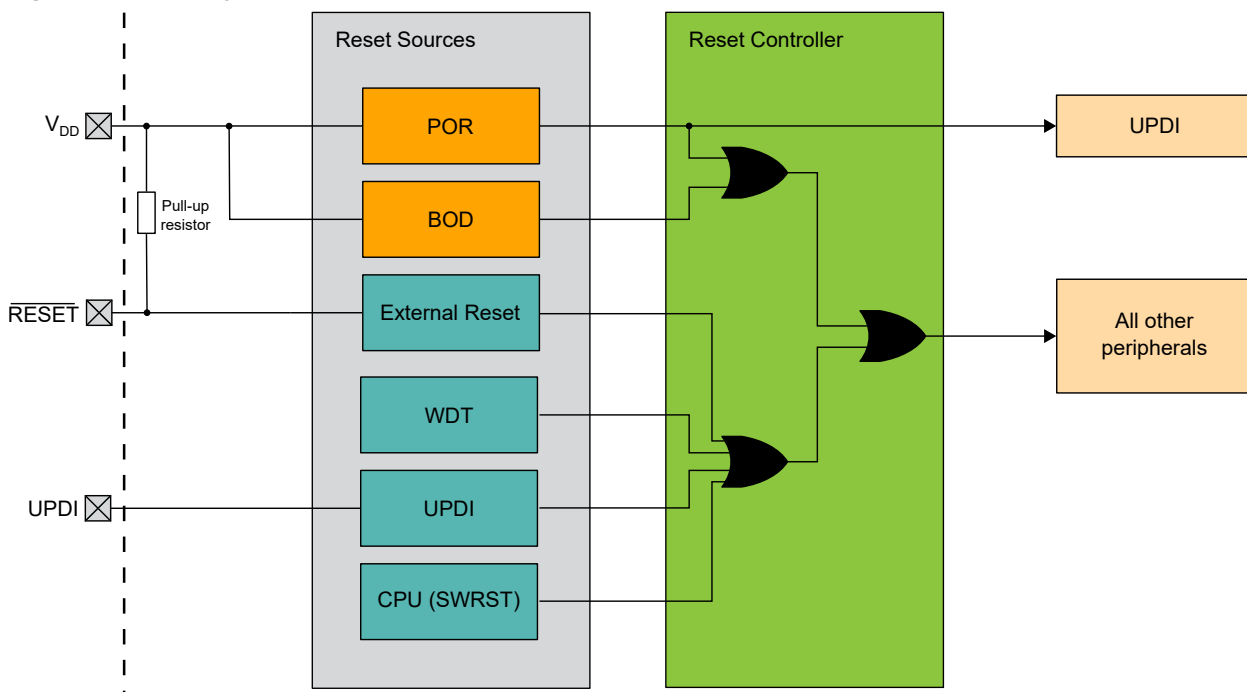
This bit controls if the EEPROM will be erased or not during a chip erase.

Value	Name	Description
0	DISABLE	EEPROM erased during chip erase
1	ENABLE	EEPROM not erased during chip erase <b>regardless of whether the device is locked or not</b>

#### 3.3 RSTCTRL - Reset Controller

A clarification has been made to add the missing block diagram figure.

Figure 3-1. Reset System Overview



### 3.4 TWI - Two-Wire Interface

A clarification of the clock stretching in the SDA Setup Time (SDASETUP) bit description in the TWI Control A (CTRLA) register has been made.

#### Bit 4 - SDASETUP SDA Setup Time

This bit is used in TWI Client mode **with clock stretching** to select the clock hold time and ensure the minimum setup time on the SDA out signal.

Value	Name	Description
0	4CYC	SDA setup time is four clock cycles
1	8CYC	SDA setup time is eight clock cycles

### 3.5 Electrical Characteristics - Peripheral Power Consumption

To update the ADC power consumption ( $I_{DD\_ADC}$ ) in the *Peripheral Power Consumption* table, a clarification has been made.

Table 37-6. Peripheral Power Consumption<sup>(1)</sup>

**Operating Conditions:**

- $V_{DD} = 3.0V$
- $T_A = 25^{\circ}C$
- OSCHF at 4 MHz used as clock source
- Device in Standby sleep mode

Symbol	Description	Min.	Typ. †	Max. 85°C	Max. 125°C	Unit	Conditions
$I_{DD\_WDT}$	Watchdog Timer (WDT)	—	600	900	1500	nA	32.768 kHz internal oscillator
$I_{DD\_VREF}$	Voltage Reference (VREF)	—	175	300	320	$\mu A$	ADC0REF enabled, $V_{REF} = 2.048V$
		—	71	90	92	$\mu A$	ACREF enabled, $V_{REF} = 2.048V$
		—	40	60	62	$\mu A$	DACREF enabled, $V_{REF} = 2.048V$
$I_{DD\_BOD}$	Brown-out Detector (BOD)	—	17	25	27	$\mu A$	Brown-out Detect (BOD) continuous
		—	1.6	10	12	$\mu A$	Brown-out Detect (BOD) sampling @128 Hz, including $I_{DD\_OSC32K}$
		—	0.95	10	12	$\mu A$	Brown-out Detect (BOD) sampling @32 Hz, including $I_{DD\_OSC32K}$
$I_{DD\_TCA}$	16-bit Timer/Counter Type A (TCA)	—	6	—	—	$\mu A$	CLK_PER = OSCHF/4 = 1 MHz
$I_{DD\_TCB}$	16-bit Timer/Counter Type B (TCB)	—	3.6	—	—	$\mu A$	
$I_{DD\_TCD}$	12-bit Timer/Counter Type D (TCD)	—	4.6	—	—	$\mu A$	
$I_{DD\_RTC}$	Real-Time Counter (RTC)	—	0.7	18	25.5	$\mu A$	RTC running at 1.024 kHz from OSC32K
		—	3.9	20	26	$\mu A$	RTC running at 1.024 kHz from XOSC32K, XOSC32KCTRLA.LPMODE = 0
		—	2.1	18	25	$\mu A$	RTC running at 1.024 kHz from XOSC32K, XOSC32KCTRLA.LPMODE = 1
$I_{DD\_OSC32K}$	32.768 kHz Internal Oscillator (OSC32K)	—	600	900	1500	nA	
$I_{DD\_XOSC32K}$	32.768 kHz Crystal Oscillator (XOSC32K)	—	2	—	—	$\mu A$	XOSC32KCTRLA.LPMODE = 0
		—	1.2	—	—	$\mu A$	XOSC32KCTRLA.LPMODE = 1
$I_{DD\_OSCHF}$	Internal High Frequency Oscillator (OSCHF)	—	185	—	—	$\mu A$	OSCHF at 4 MHz



.....continued

**Operating Conditions:**

- $V_{DD} = 3.0V$
- $T_A = 25^{\circ}C$
- OSCHF at 4 MHz used as clock source
- Device in Standby sleep mode

Symbol	Description	Min.	Typ. †	Max. 85°C	Max. 125°C	Unit	Conditions
$I_{DD\_ADC}$	Analog-to-Digital Converter (ADC)	—	300	600	650	nA	ADC - Nonconverting
		—	1.1	1.4	1.5	mA	ADC @60 ksp <sup>(2)</sup>
		—	1.1	1.5	1.6	mA	ADC @120 ksp <sup>(2)</sup>
$I_{DD\_AC}$	Analog Comparator (AC)	—	70	105	110	μA	CTRLA.POWER = 0x0
		—	17	30	32	μA	CTRLA.POWER = 0x1
		—	12	20	22	μA	CTRLA.POWER = 0x2
$I_{DD\_DAC}$	Digital-to-Analog Converter (DAC)	—	120	140	160	μA	DAC + DACOUT, $V_{DACREF} = V_{DD}/2$
		—	8	13	34	μA	DAC, $V_{DACREF} = V_{DD}/2$
$I_{DD\_UART}$	Universal Synchronous and Asynchronous Receiver and Transmitter (USART)	—	8.2	—	—	μA	USART Enabled @9600 Baud
$I_{DD\_SPI}$	Serial Peripheral Interface (SPI)	—	4	—	—	μA	SPI Host @100 kHz
$I_{DD\_TWI}$	Two-Wire Interface (TWI)	—	8	—	—	μA	TWI Host @100 kHz
		—	6	—	—	μA	TWI Client @100 kHz
$I_{DD\_NVM\_ERASE}$	Flash Programming Erase	—	6.8	—	—	mA	
$I_{DD\_NVM\_WRITE}$	Flash Programming Write	—	9.2	—	—	mA	

† Data in the “Typ.” column is at  $T_A = 25^{\circ}C$  and  $V_{DD} = 3.0V$  unless otherwise specified. These parameters are for design guidance only and are not tested.

**Notes:**

1. Current consumption of the module only. To calculate the total internal power consumption of the microcontroller, add the power consumption values of all the peripherals and the clock sources used to the base power consumption given in the *Power Consumption* section.
2. Average power consumption with ADC active in Free Running mode.

### 3.6 Electrical Characteristics - Memory Programming Specifications

A clarification has been made to change the Flash memory cell endurance specification in the *Memory Programming Specifications* table.

**Table 37-8. Memory Programming Specifications**

Symbol	Description	Min.	Typ. †	Max.	Unit	Conditions
Data EEPROM Memory Specifications						
$E_D^*$	Data EEPROM byte endurance	100k	—	—	Erase/Write cycles	$-40^\circ\text{C} \leq T_A \leq +85^\circ\text{C}$
$t_{D\_RET}$	Characteristic retention	—	40	—	Year	Provided no other violated specifications
$V_{D\_RW}$	$V_{DD}$ for Read or Erase/Write operation	$V_{DDMIN}$	—	$V_{DDMAX}$	V	
$N_{D\_REF}^*$	Total Erase/Write cycles before refresh	1M	4M	—	Erase/Write cycles	$-40^\circ\text{C} \leq T_A \leq +85^\circ\text{C}$
$t_{D\_CE}$	Byte/Multibyte/Full EEPROM Erase time	—	10	10.5	ms	
$t_{D\_WRE}$	Byte Write time	—	70	75	$\mu\text{s}$	
$t_{D\_BEW}$	Byte Erase and Write time	—	10.07	—	ms	
Program Flash Memory Specifications						
$E_p^*$	<b>Flash memory cell endurance</b>	<b>1k</b>	—	—	Erase/Write cycles	
$t_{P\_RET}$	Characteristic retention	—	40	—	Year	
$V_{P\_RD}$	$V_{DD}$ for Read operation	$V_{DDMIN}$	—	$V_{DDMAX}$	V	
$V_{P\_REW}$	$V_{DD}$ for Erase/Write operation	$V_{DD}^{(1)}$	—	$V_{DDMAX}$	V	
$t_{P\_CE}$	Chip Erase time	—	11	11.6	ms	
$t_{P\_PE}$	Page Erase time	—	10	10.5	ms	
$t_{P\_WRD}$	Byte/Word Write time	—	70	75	$\mu\text{s}$	
<p>† Data in the “Typ.” column is at <math>T_A = 25^\circ\text{C}</math> and <math>V_{DD} = 3.0\text{V}</math> unless otherwise specified. These parameters are for design guidance only and are not tested.</p> <p>* These parameters are characterized but not tested in production.</p> <p><b>Note:</b></p> <p>1. During Chip Erase, the Brown-out Detector (BOD) configured with BODLEVEL0 is forced ON. The erase attempt will fail if the supply voltage <math>V_{DD}</math> is below <math>V_{BOD}</math> for BODLEVEL0.</p>						

### 3.7 Electrical Characteristics - VREF

A clarification has been made to change the maximum accuracy of VREF in the  $V_{REF}$  Specifications table.

**Table 37-17.  $V_{REF}$  Specifications**

Symbol	Description	Min.	Typ. †	Max.	Unit	Conditions
$V_{VREF\_1V024}^{(1)}$	Internal Voltage Reference 1.024V	-4	—	<b>4</b>	%	$V_{DD} \geq 2.5\text{V}, -40^\circ\text{C} \leq T_A \leq +85^\circ\text{C}$
$V_{VREF\_2V048}^{(1)}$	Internal Voltage Reference 2.048V	-4	—	<b>4</b>	%	$V_{DD} \geq 2.5\text{V}, -40^\circ\text{C} \leq T_A \leq +85^\circ\text{C}$
$V_{VREF\_4V096}^{(1)}$	Internal Voltage Reference 4.096V	-4	—	<b>4</b>	%	$V_{DD} \geq 4.55\text{V}, -40^\circ\text{C} \leq T_A \leq +85^\circ\text{C}$
$V_{VREF\_2V500}^{(1)}$	Internal Voltage Reference 2.5V	-4	—	<b>4</b>	%	$V_{DD} \geq 2.7\text{V}, -40^\circ\text{C} \leq T_A \leq +85^\circ\text{C}$

.....continued

Symbol	Description	Min.	Typ. †	Max.	Unit	Conditions
V <sub>VREFA</sub>	VREFA input pin voltage	1.8	—	V <sub>DD</sub>	V	V <sub>DD</sub> < 2.7V
		1.024	—	V <sub>DD</sub>	V	V <sub>DD</sub> ≥ 2.7V
t <sub>INTREF</sub> *	Delay for changing voltage reference	—	2	—	µs	
t <sub>VREF_ST</sub> *	VREF Start-up Time	—	10	—	µs	CLKCTRL.MCLKCTRLA = 0x00 or 0x03
		—	200	—	µs	CLKCTRL.MCLKCTRLA = 0x01 or 0x02

† Data in the “Typ.” column is at T<sub>A</sub> = 25°C and V<sub>DD</sub> = 3.0V unless otherwise specified. These parameters are for design guidance only and are not tested.

\* These parameters are characterized but not tested in production.

**Note:**

- The symbol V<sub>VREF\_xVxxx</sub> refers to the respective values of the REFSEL bit fields in the VREF.ADC0REF, VREF.DAC0REF and VREF.ACREF registers.

### 3.8 Electrical Characteristics - DAC

A clarification has been made to update the conditions in the *DAC Electrical Specifications* table.

**Table 37-22. DAC Electrical Specifications**

Operating Conditions:						
<ul style="list-style-type: none"> <li>V<sub>DD</sub> = 3.0V</li> <li>T<sub>A</sub> = 25°C</li> </ul>						
Symbol	Description	Min.	Typ. †	Max.	Unit	Conditions
V <sub>DD</sub>	Supply voltage	1.8	—	5.5	V	
V <sub>OUT</sub>	Output voltage range	GND	—	V <sub>DD</sub>	V	
V <sub>LSB</sub>	Resolution	—	10	—	Bit	
V <sub>ACC</sub>	Absolute accuracy	—	1	—	LSb	0x023 ≤ DAC.DATA < 0x3DC
t <sub>ST</sub>	Settling Time <sup>(1)</sup>	—	7	—	µs	V <sub>DACREF</sub> = V <sub>DD</sub> = 3.0V, 50 pF Load
		—	10	—	µs	V <sub>DACREF</sub> = V <sub>DD</sub> = 5.5V, 50 pF Load
INL	Integral nonlinearity	-2.3	1	2.3	LSb	0x023 ≤ DAC.DATA < 0x3DC
DNL	Differential nonlinearity	-0.2	0.2	0.7	LSb	0x023 ≤ DAC.DATA < 0x3DC
E <sub>OFF</sub>	Offset error	1.7	2.8	5	LSb	0x023 ≤ DAC.DATA < 0x3DC
E <sub>GAIN</sub>	Gain error	-3.3	-1.1	0.7	LSb	0x023 ≤ DAC.DATA < 0x3DC

† Data in the “Typ.” column is at T<sub>A</sub> = 25°C and V<sub>DD</sub> = 3.0V unless otherwise specified. These parameters are for design guidance only and are not tested.

**Note:**

- Settling time measured while DAC.DATA[9:0] transitions from ‘0x000’ to ‘0x3FF’.

### 3.9 Electrical Characteristics - ADC

A clarification has been made for ADC Specifications in the *ADC Accuracy Specifications* table.

**Table 37-23. ADC Accuracy Specifications**

Operating Conditions:						
<ul style="list-style-type: none"> <li>• <math>V_{DD} = 3.0V</math></li> <li>• <math>T_A = 25^{\circ}C</math></li> </ul>						
Symbol	Description	Min.	Typ. †	Max.	Unit	Conditions
$N_R$	Resolution	—	—	12	bit	
$E_{INL}$	Integral nonlinearity error	-1	0.1	1	LSb	$V_{DD} = V_{REF} = 3.0V$
$E_{DNL}$	Differential nonlinearity error <sup>(1)</sup>	-1	0.1	1	LSb	$V_{DD} = V_{REF} = 3.0V$
$E_{OFF}$	Offset error	1.3	3	5	LSb	$V_{DD} = V_{REF} = 3.0V$
$E_{GAIN}$	Gain error	-5	1.5	5	LSb	$V_{DD} = V_{REF} = 3.0V$
$E_{ABS}$	Absolute error	—	—	—	LSb	$V_{DD} = V_{REF} = 3.0V$
$V_{ADCREf}$	ADC reference voltage	<b>1.8</b>	—	$V_{DD}$	V	
$V_{AIN}$	Full-scale range	GND	—	$V_{ADCREf}$	V	
$Z_{AIN}$	Recommended impedance of analog voltage source	—	<b>1</b>	—	k $\Omega$	
$R_{VREFA}$	ADC voltage reference ladder impedance <sup>(2)</sup>	—	50	—	k $\Omega$	
<p>† Data in the “Typ.” column is at <math>T_A = 25^{\circ}C</math> and <math>V_{DD} = 3.0V</math> unless otherwise specified. These parameters are for design guidance only and are not tested.</p> <p><b>Notes:</b></p> <ol style="list-style-type: none"> <li>1. The ADC conversion result never decreases with an increase in the input and has no missing codes.</li> <li>2. This is the impedance seen by the VREFA pin when the external reference is selected.</li> </ol>						

## 4. Document Revision History

**Note:** The document revision is independent of the silicon revision.

### 4.1 Revision History

Doc. Rev.	Date	Comments
D	02/2022	<ul style="list-style-type: none"> <li>• Added data sheet clarifications:               <ul style="list-style-type: none"> <li>– 3.1. Features</li> <li>– 3.2. FUSE - Configuration and User Fuses</li> <li>– 3.5. Electrical Characteristics - Peripheral Power Consumption</li> <li>– 3.6. Electrical Characteristics - Memory Programming Specifications</li> <li>– 3.7. Electrical Characteristics - VREF</li> <li>– 3.8. Electrical Characteristics - DAC</li> <li>– 3.9. Electrical Characteristics - ADC</li> </ul> </li> <li>• Updated data sheet clarifications:               <ul style="list-style-type: none"> <li>– 3.3. RSTCTRL - Reset Controller</li> <li>– 3.4. TWI - Two-Wire Interface</li> </ul> </li> </ul>
C	10/2021	<ul style="list-style-type: none"> <li>• Updated errata:               <ul style="list-style-type: none"> <li>– Device: <i>Some Reserved Fuse Bits Are '1'</i></li> <li>– Device: <i>CRC Check During Reset Initialization Is Not Functional</i></li> <li>– USART: <i>Start-of-Frame Detection Can Unintentionally Be Enabled in Active Mode When RXCIF Is '0'</i></li> </ul> </li> <li>• Added errata:               <ul style="list-style-type: none"> <li>– CLKCTRL: <i>PLL Status Not Working as Expected</i></li> <li>– DAC: <i>DAC Output Buffer Lifetime Drift</i></li> <li>– NVMCTRL: <i>Flash Multi-Page Erase Can Erase Write Protected Section</i></li> <li>– TCD: <i>Halting TCD and Wait for SW Restart Does Not Work if Compare Value A Is 0 or Dual Slope Mode Is Used</i></li> <li>– TWI: <i>Flush Nonfunctional</i></li> </ul> </li> </ul>
B	11/2020	<ul style="list-style-type: none"> <li>• Add new device revision (A4)</li> <li>• Added errata:               <ul style="list-style-type: none"> <li>– Device: <i>Some Reserved Fuse Bits Are '1'</i></li> <li>– Device: <i>CRC Check During Reset Initialization Is Not Functional</i></li> <li>– RSTCTRL: <i>BOD Registers Not Reset When UPDI Is Enabled</i></li> <li>– TCA: <i>Restart Will Reset Counter Direction in NORMAL and FRQ Mode</i></li> <li>– TCB: <i>CCMP and CNT Registers Operate as 16-Bit Registers in 8-Bit PWM Mode</i></li> <li>– TCD: <i>Asynchronous Input Events Not Working When TCD Counter Prescaler Is Used</i></li> <li>– USART: <i>Start-of-Frame Detection Can Unintentionally Be Enabled in Active Mode When RXCIF Is '0'</i></li> </ul> </li> </ul>
A	07/2020	Initial document release

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